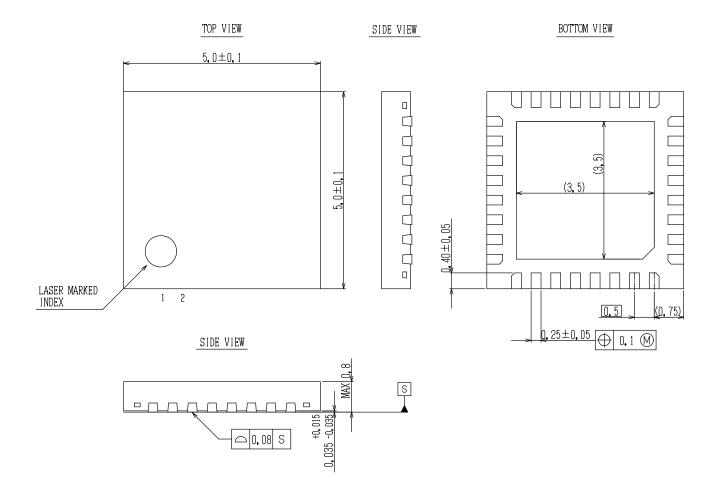


WQFN32 5x5, 0.5P / VQFN32UCASE 510AZ ISSUE A

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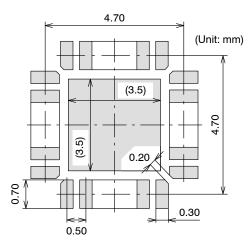


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SOLDERING FOOTPRINT*



NOTES:

- 1. The measurements are not to guarantee but for reference only.
- 2. Module level verification after set designing must be implemented. Validating solderbility and Reliability verification for joint areas such as Exposed Die-pad and must be carried out.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



XXXXXX YDD \bigcirc

XXXXX = Specific Device Code

Y = Year

M = Month

DDD = Additional Traceability Data

XXXXX = Specific Device Code

Y = Year

DD = Additional Traceability Data

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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ISSUE	REVISION	DATE
0	RELEASED FOR PRODUCTION FROM SANYO ENACT# S-580 TO ON SEMICONDUCTOR. REQ. BY D. TRUHITTE.	30 JUN 2012
Α	ADDED MARKING AND SOLDER FOOTPRINT INFORMATION. REQ. BY D. TRUHITTE.	05 DEC 2013

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